

#### PCN# 20151016001A Qualification of AMKOR P1 as Additional Assembly and Test Site for Select SOIC Package Devices Change Notification / Sample Request

Dear Customer:

Revision A is to update the description of change to provide correction on the material differences table. Devices under Group 2 will include Cu wire changes. We apologize for any inconvenience this may have caused.

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If you require samples or additional data to support your evaluation, please request within 30 days.

The changes discussed within this PCN will not take effect any earlier than **90** days from the date of this notification, unless customer agreement has been reached on an earlier implementation of the change. This notification period is per TI's standard process.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (<u>PCN\_ww\_admin\_team@list.ti.com</u>).

Sincerely,

PCN Team SC Business Services

#### PCN# 20151016001A Attachment: 1

## **Products Affected:**

According to our records, there are the affected device(s) that you have purchased within the past twenty-four (24) months. Technical details of this Product Change follow on the next page(s).

PCN Number:		2	20151016001A					PCN Date:	10/27	/2015	
Qualification											
Title: Qualification of AMKOR P1 as Additional Assembly and Test Site for Select SOIC   Package Devices											
Customer Contact:		<u>P(</u>	CN Manage	<u>er</u>	De	pt:	Quality	Servio	ces		
Proposed	1 <sup>st</sup> Ship Da	ite:	01/22/2	201	6	Estimated Availabilit	-		e Provided uest	at Samp	е
Change T	Change Type:										
Asser	nbly Site		Design				Wafer Bump Site				
	mbly Process	5			Data Sheet				Wafer Bump Mate		rial
	mbly Materia				Part number change				Wafer Bump Process		
	anical Speci				Test Site				Wafer Fab Site		
🛛 Packi	ng/Shipping	/Lab	eling		Te	st Process			Wafer Fab Materials Wafer Fab Process		
					_				Water Fai	o Process	
Decorinti	on of Chony				<u>Р</u>	CN Detail	S				
	on of Chang		descripti	ion		nange to prov	vide corr	ection	on the mat	erial diff	arences
						a wire chang					
may have			<u> </u>					.porogi			
						ing the quali					
						sted in the "F	Product A	Affecte	d" Section.	Current	
assembly	sites and Ma	teria	I differen	ices	are	as follows.					
Accombly											
Assembly Site Assembly Site Origin Assembly Country Code   TI Mexico MEX MX						Assembly Site City Aguascalientes					
				_		MX MY			-		
TI Malaysia	a								Kuala Lump	JI	
			ASH		CN PH		Shanghai				
AIIIKOI PT	Amkor P1AKRPHCupang, Muntinlupa City										
Material [	Differences										
Material		•									
Group 1 D	Devices:										
		-	TI Mexico			TI Malaysia		ASES	н д	MKOR P	1
Mount Compound			4147858			4042500	E	EY1000063		0137528	
Mold Compound 42		4211880		4211880 E		El	N20000509		0138075	3	
Lead Finish NiPdAu				NiPdAu Matt			Matte S	Sn	Matte Sn		
Group 2 [	Devices:										
			ASESH		AMKOR P1						
Mount Cor	Mount Compound		EY1000063			101375281					
Wire Type			Au			Cu					
Mold Com	pound	E	EN20000509			101380756					
Lead Finish			Matte Sn		Matte Sn						
Lead Finis	h		Matte Sn			Matte Sn					

Upon expiration of this PCN, TI will combine lead free solutions in a single <u>standard part number</u>, for example; <u>LM224ADR</u> – can ship with both Matte Sn and NiPdAu. When available customers may specify NiPdAu finish by ordering the part with the G4 suffix, e.g. **LM224ADRG4**."

Test coverage, insertions, conditions will remain consistent with current testing and verified with test MQ.

Reas	on for Change:								
	nuity of supply.								
	ipated impact o	n Form	it Eurotion (	Quality or	Poliabi		nocitivo /	nogat	ivo):
	ipated impact o	n Form, i	rit, Function, C	Juanty of	Reliab	inty (	positive /	negat	ive):
None									
Antic	ipated impact o								
	No Impact to the Material Declarat								
Chan	ges to product i	dentifica	tion resulting	from this	PCN:				
Δοσ	sembly Site								
	Mexico	Assembl	y Site Origin (2	2I) A	SO: ME	x	ECAT:	G4	
	Malaysia		y Site Origin (2	,	SO: ML/		ECAT:		
ASE	3		y Site Origin (2		SO: ASI		ECAT:		
	kor P1		y Site Origin (2	,	SO: AK		ECAT:		
	TEXAS STRUMENTS DE IN: Malaysia	<b>P</b> G4	ECAT: G4 = N ECAT: G3 = N	latte Sn (1P)	SN74LS				
MAD 2DC MSL MSL OPT ITE	DE IN: Malaysia 20: 2 /260C/1 YEAR S 1 /235C/UNLIM 0	29 39 1750	ECAT: G3 = N	(1P) (Q) (31T) (4W) T (P) (2P) RE (20L) C (22L) A	2000 LOT: 39 KY(1T) SO: SHE SO: SHE	(D) 95904 ) 752 (V) (21L) (23L)	0336 7MLA 3483512 0033317 CC0:USA AC0: MYS		
	DE IN: Malaysia 20: 2 /260C/1 YEAR S 1 /235C/UNLIM 0 :: M: L: 5A (L)TO:	39 1750 5: TI-Mex	ECAT: G3 = N	(1P) (Q) (31T) (4W) T (P) (2P) RE (20L) C (22L) A	2000 LOT: 39 KY(1T) SO: SHE SO: SHE	(D) 95904 ) 752 (V) (21L) (23L)	0336 7MLA 3483512 0033317 CC0:USA AC0: MYS		
MAD 2000 MSL MSL MSL MSL MSL MSL MSL MSL MSL MSL	DE IN: Malaysia 20: 2 /260C/1 YEAR S 1 /235C/UNLIM 0 MELY SITE CODES MBLY SITE CODES MUCT Affected: Gr 24ADR	EAL DT 33/29/04   39 1750   5: TI-Mex   coup 1   LM324A	ECAT: G3 = N ico = M , TI-Ma	(1P) (Q) (31T) (4W) T (P) (2P) RE (20L) C (22L) A alaysia = K	2000 LOT: 39 KY (1T) SO: SHE SO: SHE SO: MLA	(D) 95904 ) 752 (V) (21L) (23L) H = A	0336 7MLA 3483SI2 0033317 CC0:USA AC0: MYS , AP1 = 4	33	
MAD 2000 MSL MSL MSL MSL MSL MSL MSL MSL MSL MSL	DE IN: Malaysia 20: 2 /260C/1 YEAR S 1 /235C/UNLIM 0 MELY SITE CODES MUCT Affected: Gr 24ADR 24DR	EAL DT 3/29/04 39 1750 5: TI-Mex COUP 1 LM324A LM324D	ICO = M , TI-Ma	(1P) (Q) (31T) (4W) T (P) (2P) RE (20L) C (22L) A alaysia = K LM358ADF LM2901DF	2000 LOT: 39 KY (11) SO: SHE SO: SHE SO: MLA	(D) 95904 ) 752 (V) (21L) (23L) H = A	0336 7MLA 3483SI2 0033317 CCO:USA ACO: MYS , AP1 = 4		
Prod	DE IN: Malaysia 20: 2 /260C/1 YEAR S 1 /235C/UNLIM 0 II: 5A (L)TO: MBLY SITE CODES MBLY SITE CODES MBLY SITE CODES MUCT Affected: Gr 24ADR 24DR 24DR	EAL DT 3/29/04 39 1750 5: TI-Mex COUP 1 LM324A LM324D LM324D	ECAT: G3 = N ico = M , TI-Ma DR R RG3	(1P) (Q) (31T) (4W) T (P) (2P) RE (20L) C (22L) A alaysia = K LM358ADF LM2901DF LM2901DF	2000 LOT: 39 KY (11) So: SHE So: MLA ASESF	(D) 95904 ) 752 (V) (21L) (23L) H = A	0336 7MLA 3483S12 0033317 CCO:USA ACO: MYS , AP1 = 4		
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Prod	E IN: Malaysia 20: 2 /260C/1 YEAR S 1 /235C/UNLIM 0 II: 5A (L)TO: MBLY SITE CODES MUCT Affected: Gr 24ADR 24DR 24DR 39DR 39DR 39DR 3	EAL DT 3/29/04 39 1750 5: TI-Mex COUP 1 LM324A LM324D LM324D LM324D LM329D	ECAT: G3 = N ECAT: G3 = N ICO = M , TI-Ma DR R R RG3 R-M R	Aatte Sn (1P) (Q) (31T) (4W) T (2P) RE (20L) Q (22L) A alaysia = K LM358ADF LM2901DF LM2901DF LM2902DF LM2903DF	2000 LOT: 39 KY (117) SO: SHE SO: SHE SO: MLA A , ASESH	(D) 95904 ) 752 (V) (21L) (23L) H = A	0336 7MLA 3483SI2 0033317 CCO:USA ACO: MYS , AP1 = 4	3 /1	
Prod	E IN: Malaysia 20: 2 /260C/1 YEAR 1 /235C/UNLIM 0 HELY SITE CODES MBLY SITE CODES MBLY SITE CODES MBLY SITE CODES MUCT Affected: Gr 24DR 24DR 24DR 24DR 39DR 39DR 39DR 39DR 39DR 39DR	EAL DT 3/29/04 39 1750 S: TI-Mex COUP 1 LM324D LM324D LM324D LM339D LM339D	ECAT: G3 = N ECAT: G3 = N ICO = M , TI-Ma DR R R RG3 R-M R	Atte Sn (1P) (Q) (31T) (4W) T (P) (2P) RE (20L) C (22L) A alaysia = K LM358ADF LM2901DF LM2901DF LM2902DF	2000 LOT: 39 KY (117) SO: SHE SO: SHE SO: MLA A , ASESH	(D) 95904 ) 752 (V) (21L) (23L) H = A	0336 7MLA 3483S12 0033317 CCO:USA ACO:MYS , AP1 = 4 	3 /1	
Prod LM22 LM22 LM22 LM22 LM23	E IN: Malaysia 20: 2 /260C/1 YEAR S 1 /235C/UNLIM 0 II: 5A (L)TO: MBLY SITE CODES MUCT Affected: Gr 24ADR 24DR 24DR 39DR 39DR 39DR 3	EAL DT 3/29/04 39 1750 S: TI-Mex COUP 1 LM324D LM324D LM324D LM339D LM339D	ECAT: G3 = N ECAT: G3 = N ICO = M , TI-Ma DR R R RG3 R-M R	Aatte Sn (1P) (Q) (31T) (4W) T (2P) RE (20L) Q (22L) A alaysia = K LM358ADF LM2901DF LM2901DF LM2902DF LM2903DF	2000 LOT: 39 KY (117) SO: SHE SO: SHE SO: MLA A , ASESH	(D) 95904 ) 752 (V) (21L) (23L) H = A	0336 7MLA 3483SI2 0033317 CCO:USA ACO: MYS , AP1 = 4	3 /1	

# Qualification Report Amkor SOIC - 8D Offload

#### **Product Attributes**

Attributes	Qual Device: LM358DR	Qual Device: LM393DR
Assembly Site	AMKOR AP1	AMKOR AP1
Package Family	SOIC	SOIC
Flammability Rating	UL 94 V-0	UL 94 V-0
Wafer Fab Supplier	SFAB	SFAB
Wafer Process	JI1	JI1

- QBS: Qual By Similarity

- Qual Devices qualified at LEVEL1-260CG: LM358DR, LM393DR

## **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: LM358DR	Qual Device: LM393DR
AC	Autoclave 121C	96 Hours	3/231/0	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass
FLAM	Flammability (IEC 695-2-2)		3/15/0	3/15/0
FLAM	Flammability (UL 94V-0)		3/15/0	3/15/0
FLAM	Flammability (UL-1694)		3/15/0	3/15/0
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	3/231/0
HTOL	Life Test, 150C	300 Hours	3/231/0	-
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/229/0	3/231/0
LI	Lead Fatigue	Leads	3/66/0	3/66/0
LI	Lead Pull to Destruction	Leads	3/66/0	3/66/0
PD	Physical Dimensions		3/60/0	3/60/0
SD	Solderability	PB Free	3/66/0	3/66/0
TC	Temperature Cycle, -65/150C	500 cycles	3/230/0	3/231/0
WBP	Bond Pull	Wires	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours,

150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

### Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

# Qualification Report Amkor SOIC - 14D Offload

## **Product Attributes**

Attributes	Qual Device: LM324ADR
Assembly Site	AMKOR P1
Package Family	SOIC
Flammability Rating	UL 94 V-0
Wafer Fab Supplier	SFAB
Wafer Process	JI1

- QBS: Qual By Similarity

- Qual Device LM324ADR is qualified at LEVEL1-260CG

#### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed						
Туре	Test Name / Condition	Duration	Qual Device: LM324ADR			
AC	Autoclave 121C	96 Hours	3/231/0			
ED	Electrical Characterization	Per Datasheet Parameters	Pass			
FLAM	Flammability (IEC 695-2-2)		3/15/0			
FLAM	Flammability (UL 94V-0)		3/15/0			
FLAM	Flammability (UL-1694)		3/15/0			
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0			
HTOL	Life Test, 150C	300 hours	3/231/0			
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/229/0			
LI	Lead Fatigue	Leads	3/66/0			
LI	Lead Pull to Destruction	Leads	3/66/0			
PD	Physical Dimensions		3/60/0			
SD	Solderability	PB-Free	3/66/0			
TC	Temperature Cycle -65/150C	500 Cycles	3/231/0			
WBP	Bond Pull	Wires	3/228/0			
WBS	Ball Bond Shear	Wires	3/228/0			

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

#### Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com